

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
25V	4Ω @ V <sub>GS</sub> = 4.5V	0.26A
250	$5\Omega @ V_{GS} = 2.7V$	0.23A

#### Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

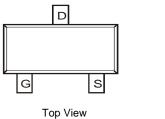
- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.

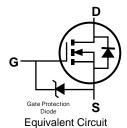
#### Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate (>6kV Human Body Model)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 3
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe).
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)





Pin Configuration

### Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMG301NU-7	Standard	SOT23	3,000/Tape & Reel
DMG301NU-13	Standard	SOT23	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

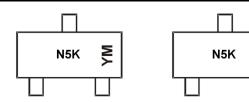
**Top View** 

 See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



N5K = Product Type Marking Code <u>YM</u> = Date Code Marking for SAT (Shanghai Assembly/ Test Site) <u>YM</u> = Date Code Marking for CAT (Chengdu Assembly/ Test Site) Y or <u>Y</u> = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		А	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	Q	0	N	D

<u>γ</u>



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V <sub>DSS</sub>	25	V		
Gate-Source Voltage		V <sub>GSS</sub>	8	V	
Continuous Drain Current (Note 6) $V_{GS}$ = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	۱ <sub>D</sub>	0.26 0.21	А
Continuous Drain Current (Note 6) $V_{GS}$ = 2.7V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	۱ <sub>D</sub>	0.23 0.18	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I <sub>DM</sub>	1.5	А		
Maximum Body Diode Continuous Current (Note 6)	Is	0.5	А		

# **Thermal Characteristics**

Characteristic		Symbol	Value	Units	
Total Power Dissipation	(Note 5)	D	0.32	W	
	(Note 6)	PD	0.4	vv	
Thermal Resistance, Junction to Ambient	(Note 5)	Р	369		
Thermal Resistance, Junction to Ambient	(Note 6)	R <sub>θJA</sub>	296	°C/W	
Thermal Resistance, Junction to Case	(Note 6)	R <sub>θJC</sub>	115		
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

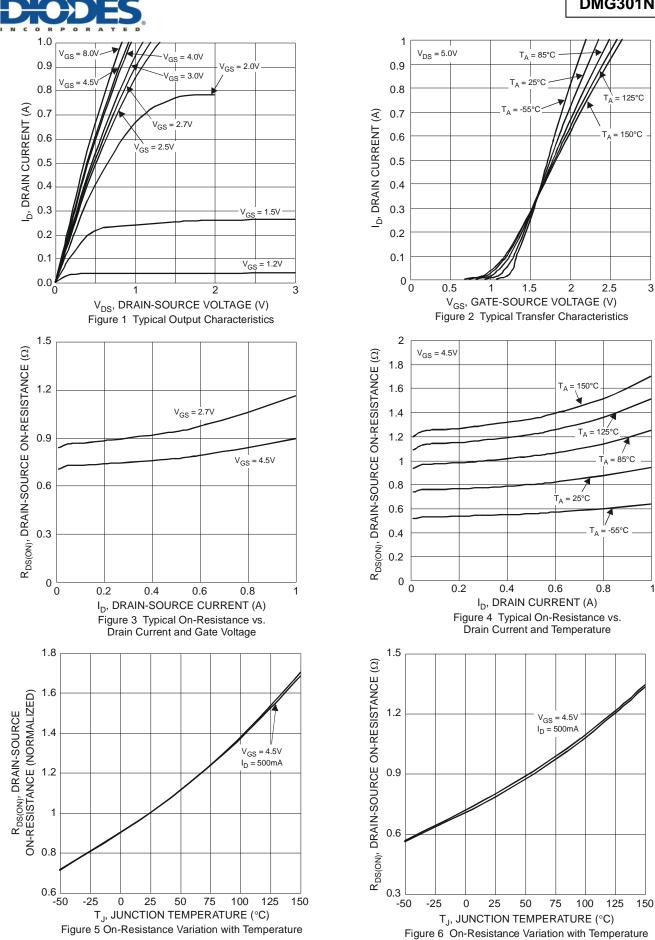
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						-	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	25		_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_		1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Body Leakage	I <sub>GSS</sub>	_		100	nA	$V_{GS} = 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.7		1.1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Statia Drain Course On Desistance		_	_	4	Ω	$V_{GS} = 4.5 V, I_D = 0.4 A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_		5	Ω	$V_{GS} = 2.7 V, I_D = 0.2 A$	
Forward Transconductance	<b>g</b> fs	_	1	_	S	$V_{DS} = 5V, I_D = 0.4A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.76	1.2	V	$V_{GS} = 0V, I_{S} = 0.29A$	
DYNAMIC CHARACTERISTICS (Note 8)						-	
Input Capacitance	Ciss	_	27.9	42			
Output Capacitance	Coss	_	6.1	9.2	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss		2.0	3.0		1 = 1.00012	
Gate Resistance	R <sub>G</sub>		26.4		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg		0.36				
Gate-Source Charge	Q <sub>gs</sub>		0.06		nC	$V_{GS} = 4.5V, V_{DS} = 5V,$	
Gate-Drain Charge	Q <sub>gd</sub>		0.04	—	1	$I_D = 0.2A$	
Turn-On Delay Time	t <sub>D(on)</sub>		2.9				
Turn-On Rise Time	tr		1.8			V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 6V	
Turn-Off Delay Time	t <sub>D(off)</sub>	_	6.6	_	nS	$I_{\rm D} = 0.5 {\rm A}, {\rm R}_{\rm G} = 50 {\Omega}$	
Turn-Off Fall Time	t <sub>f</sub>	_	2.3		1		

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

## **DMG301NU**



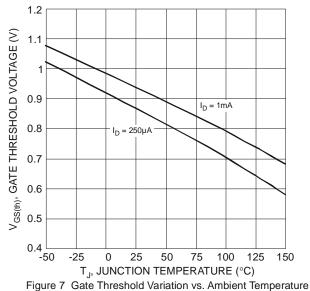
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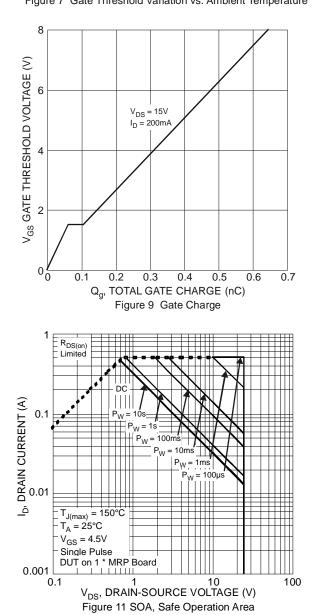
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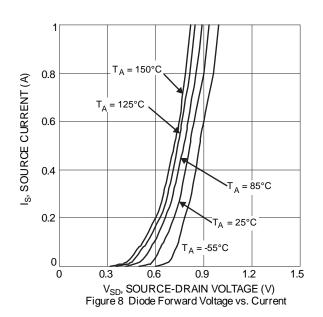
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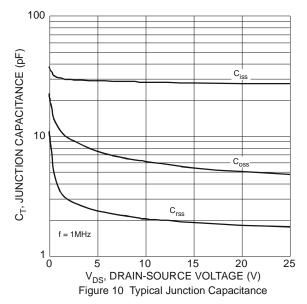
## DMG301NU





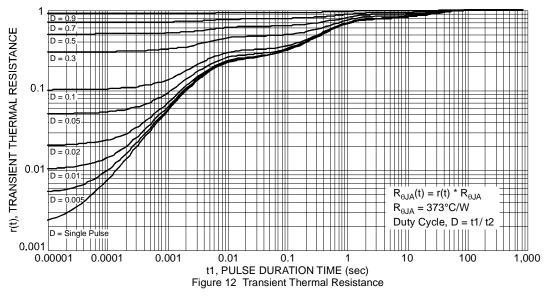






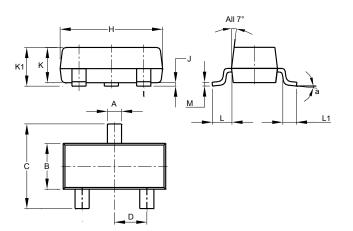
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## **Package Outline Dimensions**

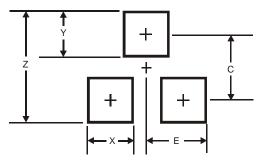
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SO	T23	
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
К	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
М	0.085	0.150	0.110
а		8°	
All	Dimens	ions in	mm

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)				
Z	2.9				
Х	0.8				
Y	0.9				
С	2.0				
E	1.35				



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